

Features

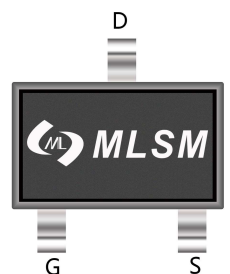
- Trench Power LV MOSFET technology with Low $R_{DS(on)}$
- High Power and current handing capability

Product Summary

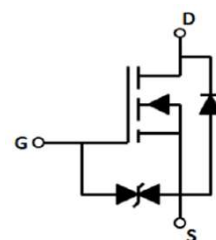
V_{DS}	$R_{DS(on)}$ MAX	I_D MAX
30V	500mΩ@4.0V	0.6A
	600mΩ@2.5V	

Application

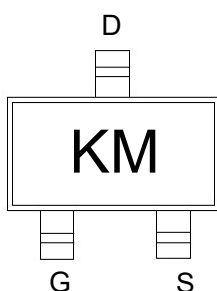
- Load/Power Switching
- Interfacing Switching
- Logic Level Shift



SOT-323 top view



Schematic diagram



KM: Device code

Marking and pin assignment



Pb-Free



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V _{DS}	Drain-Source Breakdown Voltage		30	V
V _{GS}	Gate-Source Voltage		±12	V
T _J	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-50 to 155	°C
I _S	Diode Continuous Forward Current	Tc=25°C	0.6	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_C=25^{\circ}C$	3	A
I_D	Continuous Drain Current	$T_C=25^{\circ}C$	0.6	A
P_D	Maximum Power Dissipation	$T_C=25^{\circ}C$	0.2	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient		625	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLS3144KW	SOT-323	KM	3,000	45,000	180,000	7"reel



Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V	--	--	±20	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	--	1.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =4.0V, I _D =0.6A	--	320	500	mΩ
		V _{GS} =2.5V, I _D =0.3A	--	410	600	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =10V, V _{GS} =0V, f=1MHz	--	44	--	pF
C _{OSS}	Output Capacitance		--	15	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	8	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =15V, I _D =0.8A, V _{GS} =4.5V	--	1.2	--	nC
Q _{gs}	Gate Source Charge		--	0.28	--	nC
Q _{gd}	Gate Drain Charge		--	0.3	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =15V, I _D =0.7A, V _{GS} =4.5V, R _G =51Ω	--	5	--	nS
t _r	Turn-on Rise Time		--	8.2	--	nS
t _{d(off)}	Turn-Off Delay Time		--	23	--	nS
t _f	Turn-Off Fall Time		--	41	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	Tj=25°C, Is=0.6A	--	--	1.2	V

Typical Operating Characteristics

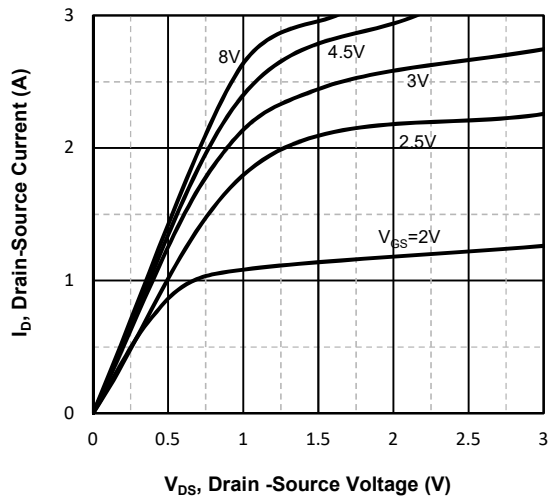


Fig1. Typical Output Characteristics

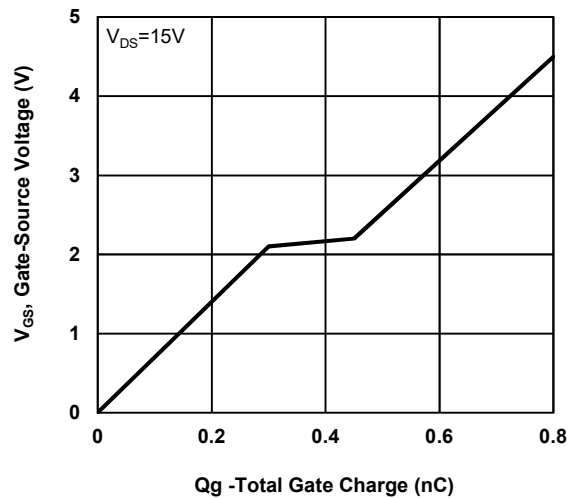


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

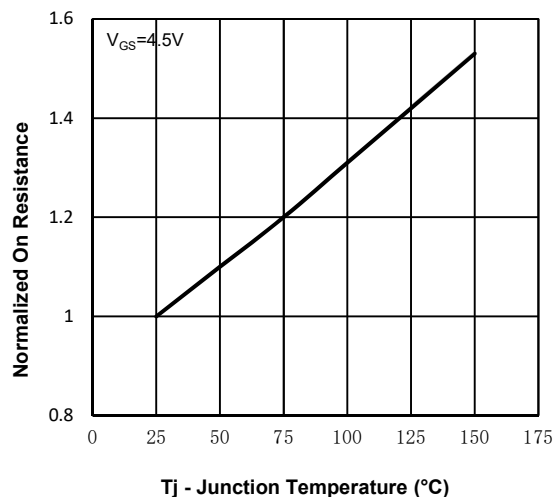


Fig3. Normalized On-Resistance Vs. Temperature

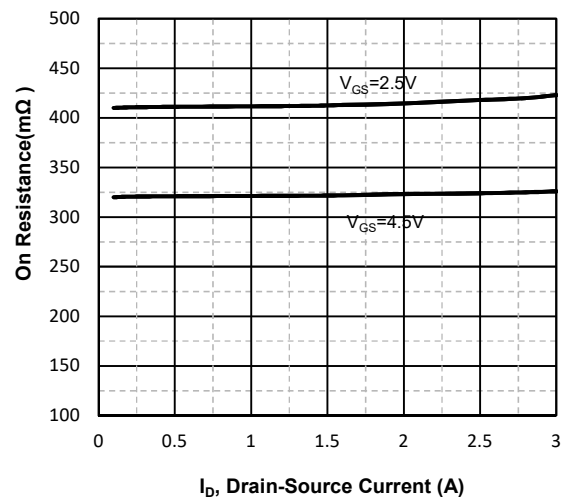


Fig4. On-Resistance Vs. Drain-Source Current

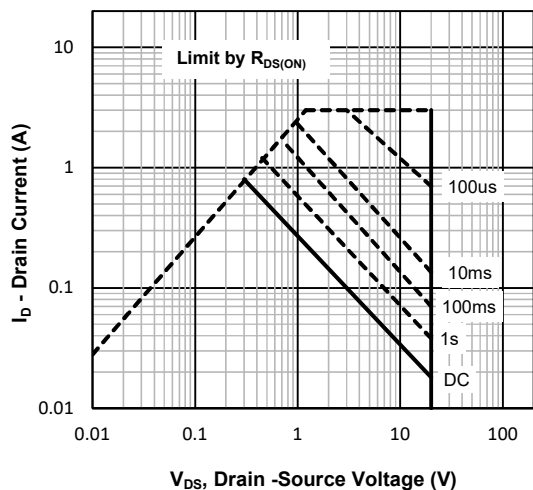


Fig5. Maximum Safe Operating Area

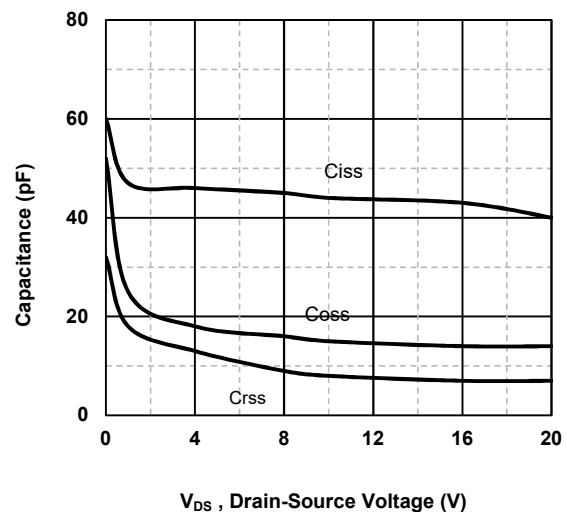
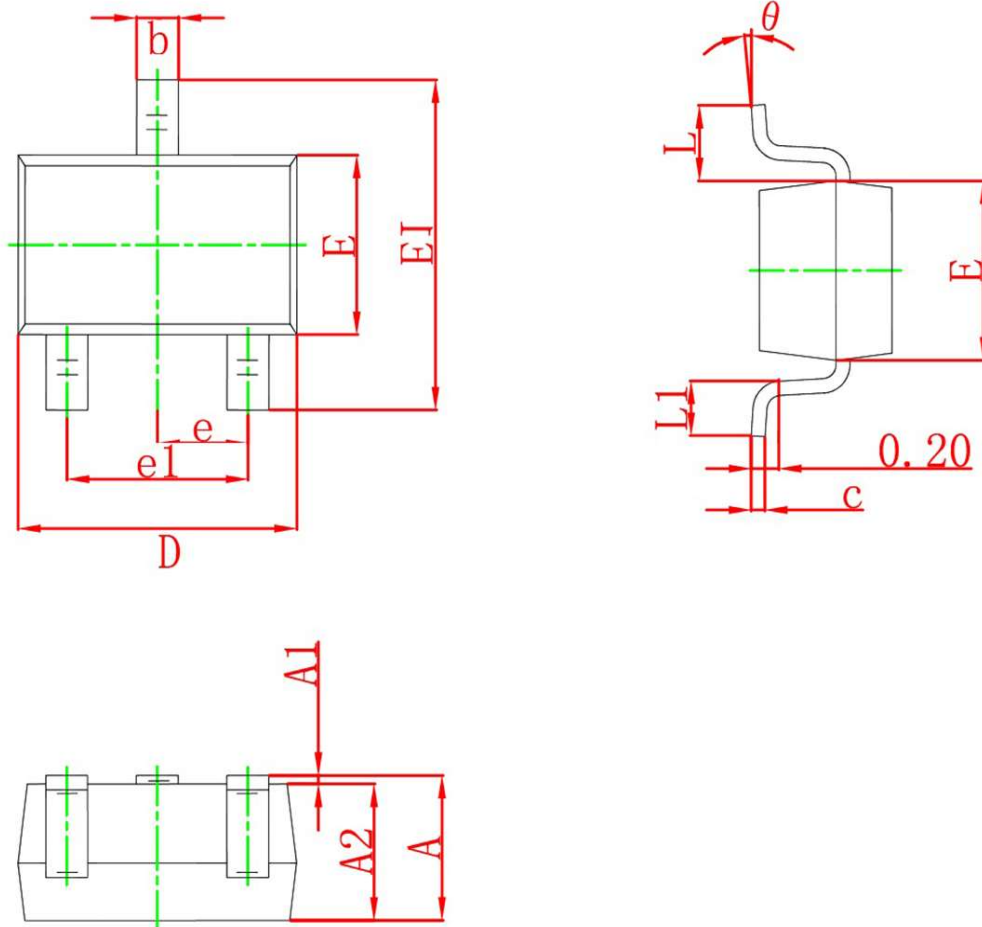


Fig6. Typical Capacitance Vs. Drain-Source Voltage

SOT-323 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.525REF		0.021REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°